

# White SMD LED, PLCC-6



## Features

- PLCC-6 package.
- White package.
- High reliability package with silicone encapsulation.
- Ideal for backlight and light pipe application.
- Suitable for reflow and wave solder processes.
- The product itself will remain within RoHS compliant Version



## Applications:

- Non-automotive use.
- General Signage backlighting.
- Amusement machine backlighting.
- Industrial lighting.
- Light strips.

## Descriptions:

- These SMT LEDs have high reliability performance and are designed to work under a wide range of environmental conditions. This high reliability feature makes them ideally suited to be used as interior signs application conditions.
- The wide viewing angle at 120° makes these LEDs ideally suited for panel, push button, industrial equipment, and home appliances. The flat top emitting surface makes it easy for these LEDs to mate with light pipes. With the built-in rector pushing up the intensity of the light output, these LEDs are also suitable to be used as LED pixels in interior electronic signs

## Absolute Maximum Ratings at Ta=25°C

Parameters	Symbol	Max.	Unit
Power Dissipation	Pd	90 x 3	mW
Peak Forward Current <sup>(a)</sup>	IFP	100 x 3	mA
DC Forward Current <sup>(b)</sup>	IF	25 x 3	mA
Reverse Voltage	VR	5	V
Electrostatic Discharge (HBM)	ESD	1000	V
Operating Temperature Range	Topr	-40°C to +80°C	
Storage Temperature Range	Tstg	-40°C to +85°C	
Soldering Temperature	Tsld	260°C for 5 Seconds	

### Notes:

- Derate linearly as shown in derating curve.
- Duty Factor = 10%, Frequency = 1 kHz

## Device Selection Guide

Part No.	Emitting Color	Lens Color
RND 135-00242	Cool White	Yellow Diffused

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## Electrical Optical Characteristics at Ta 25°C

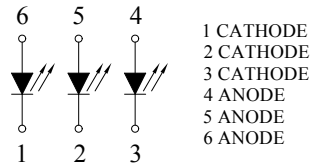
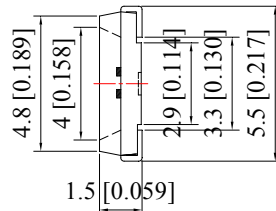
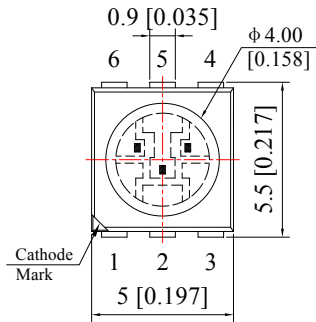
Parameters	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity <sup>(a)</sup>	IV	5800	6500	---	mcd	IF=20mA×3=60mA
Luminous Flux <sup>(a)</sup>	Φv	20	22	---	lm	IF=20mA×3=60mA
Viewing Angle <sup>(b)</sup>	2θ1/2	---	120	---	Deg	IF=20mA×3=60mA
Chromaticity Coordinates <sup>(c)</sup>	x	---	0.31	---		IF=20mA×3=60mA
	y	---	0.32	---		
Color Temperature	CCT	5000	6500	---	K	IF=20mA×3=60mA
Color Rendering Index	CRI	70	---	---	Ra	IF=20mA×3=60mA
Forward Voltage	VF	2.80	3.20	3.60	V	IF=20mA×3=60mA
Reverse Current	IR	---	---	10	μA	VR=5V

### Notes:

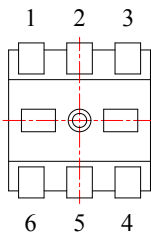
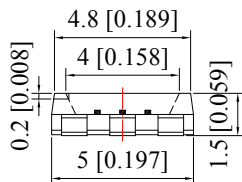
- Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- 2θ1/2 is the o-axis angle where the luminous intensity is 1/2 the peak intensity
- The dominant wavelength (λd) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

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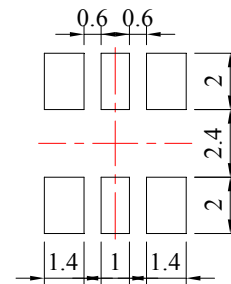
## Package Dimensions



### Polarity



### Recommended Soldering Pad dimensions



Unit: mm  
Tolerance:  $\pm 0.10\text{mm}$

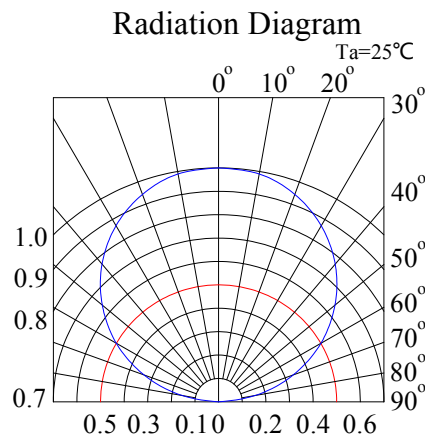
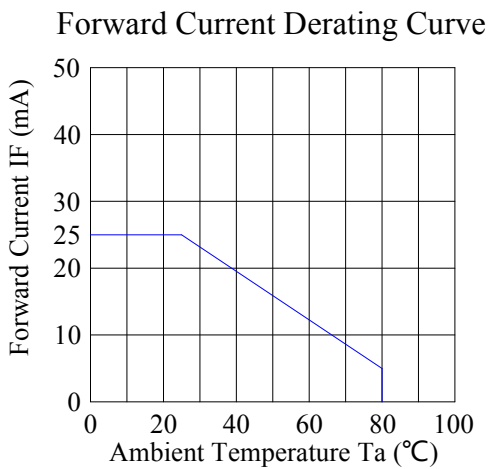
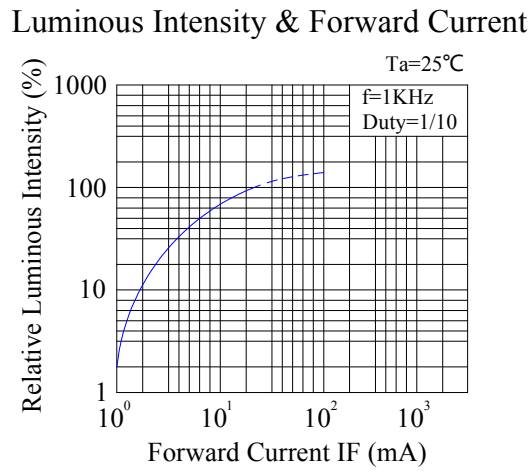
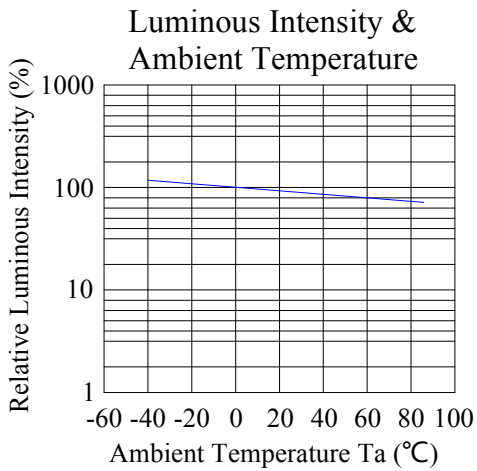
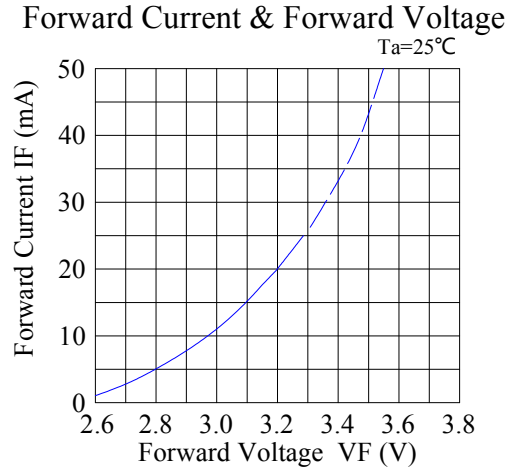
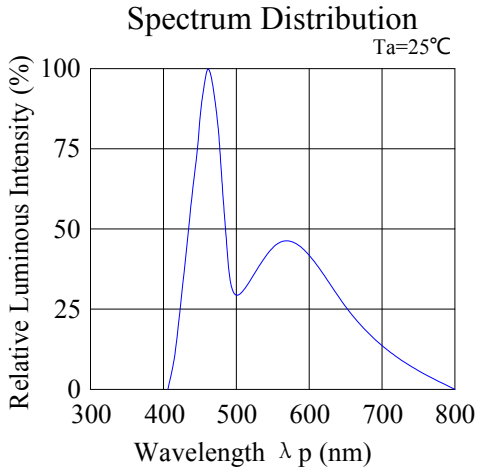
### Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.25\text{ mm}$  (.010") unless otherwise noted.

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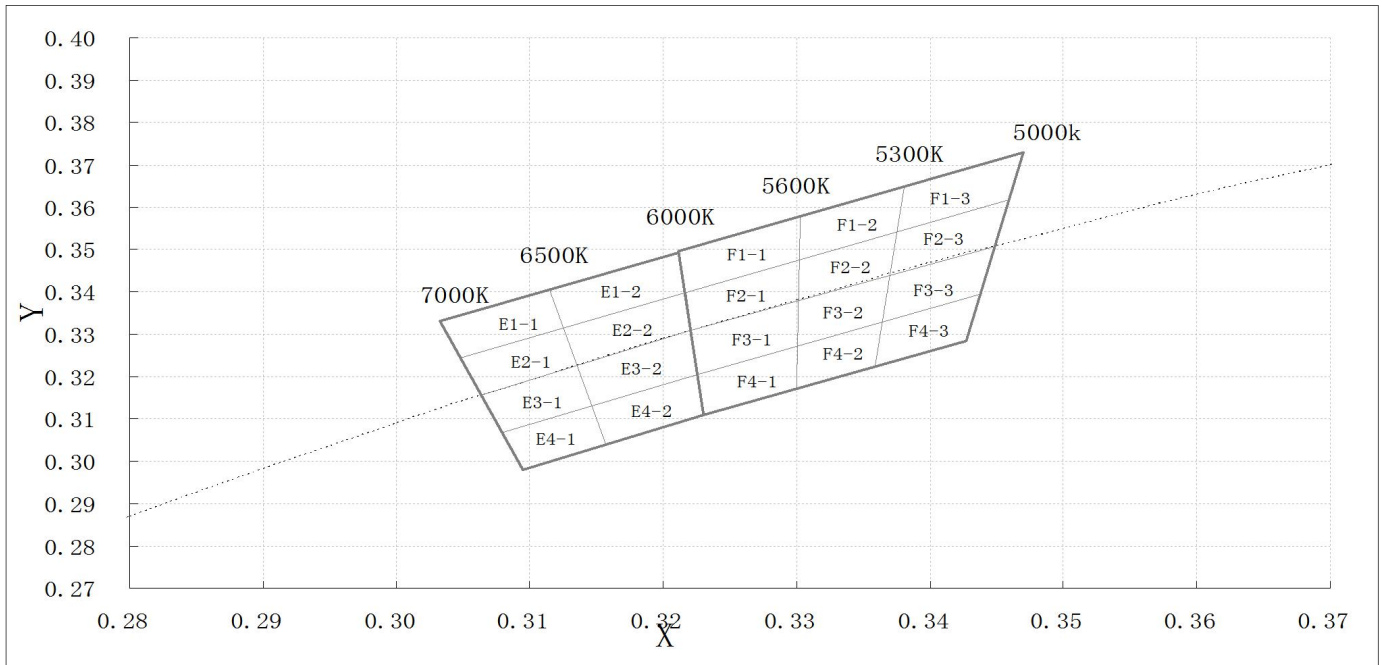
## Typical Electrical / Optical Characteristics Curves (25°C Ambient Temperature Unless Otherwise Noted)



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## CIE 1931 Chromaticity Diagram:



## Chromaticity Coordinates Specifications for Bin Rank

Bin Code	Left x	Left y	Top x	Top y	Right x	Right y	Bottom x	Bottom y
E1-1	0.305	0.324	0.313	0.331	0.312	0.341	0.303	0.333
E2-1	0.306	0.316	0.314	0.323	0.313	0.331	0.305	0.324
E3-1	0.308	0.307	0.315	0.313	0.314	0.323	0.306	0.316
E4-1	0.310	0.298	0.316	0.304	0.315	0.313	0.308	0.307
E1-2	0.313	0.331	0.323	0.340	0.323	0.349	0.312	0.341
E2-2	0.314	0.323	0.323	0.330	0.323	0.340	0.313	0.331
E3-2	0.315	0.313	0.323	0.321	0.323	0.330	0.314	0.323
E4-2	0.316	0.304	0.323	0.311	0.323	0.321	0.315	0.313
F1-1	0.323	0.340	0.330	0.347	0.330	0.357	0.323	0.349
F2-1	0.323	0.330	0.330	0.337	0.330	0.347	0.323	0.340
F3-1	0.323	0.321	0.330	0.327	0.330	0.337	0.323	0.330
F4-1	0.323	0.311	0.330	0.317	0.330	0.327	0.323	0.321
F1-2	0.330	0.347	0.337	0.354	0.338	0.365	0.330	0.357
F2-2	0.330	0.337	0.337	0.343	0.337	0.354	0.330	0.347
F3-2	0.330	0.327	0.337	0.333	0.337	0.343	0.330	0.337
F4-2	0.330	0.317	0.337	0.322	0.337	0.333	0.330	0.327
F1-3	0.337	0.354	0.346	0.362	0.347	0.373	0.338	0.365
F2-3	0.337	0.343	0.345	0.351	0.346	0.362	0.337	0.354
F3-3	0.337	0.333	0.344	0.340	0.345	0.351	0.337	0.343
F4-3	0.337	0.322	0.343	0.328	0.344	0.340	0.337	0.333

### Notes:

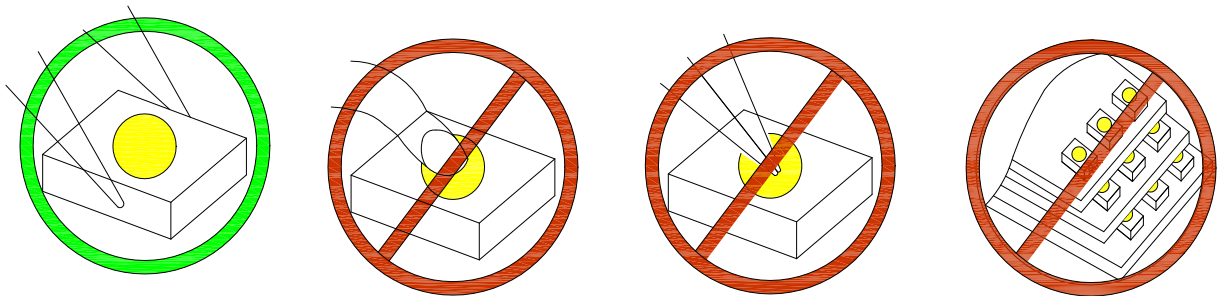
1. Color coordinates measurement allowance is  $\pm 0.15$ .
2. One delivery will include up to two consecutive color ranks and three luminous intensity ranks of the products the quantity-ratio of the ranks is decided by RND

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## CAUTIONS

### 1. Handling Precautions:

- 1.1. Handle the component along the side surfaces by using forceps or appropriate tools.
- 1.2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.
- 1.3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

### 2. Storage

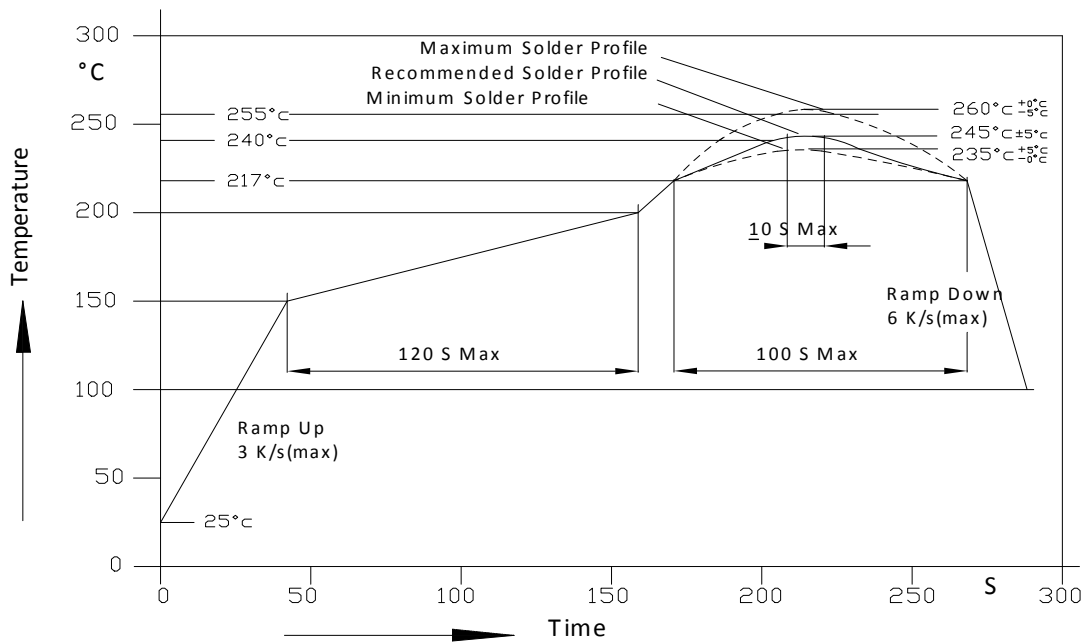
- 2.1. Do not open moisture proof bag before the products are ready to use.
- 2.2. Before opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.
- 2.3. The LEDs should be used within a year.
- 2.4. After opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.
- 2.5. The LEDs should be used within 24 hours after opening the package.
- 2.6. If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 65±5°C for 24 hours.

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## 3. Soldering Condition

### 3.1. Pb-free solder temperature profile



- 3.2. Reflow soldering should not be done more than two times.
- 3.3. When soldering, do not put stress on the LEDs during heating.
- 3.4. After soldering, do not warp the circuit board.
- 3.5. Recommended soldering conditions:

Reflow soldering		Soldering iron	
Pre-heat	150~200°C	Temperature	300°C Max. 3
Pre-heat time	120 sec. Max.	Soldering time	sec. Max.
Peak temperature	260°C Max.		(one time only)
Soldering time	10 sec. Max. (Max. two times)		

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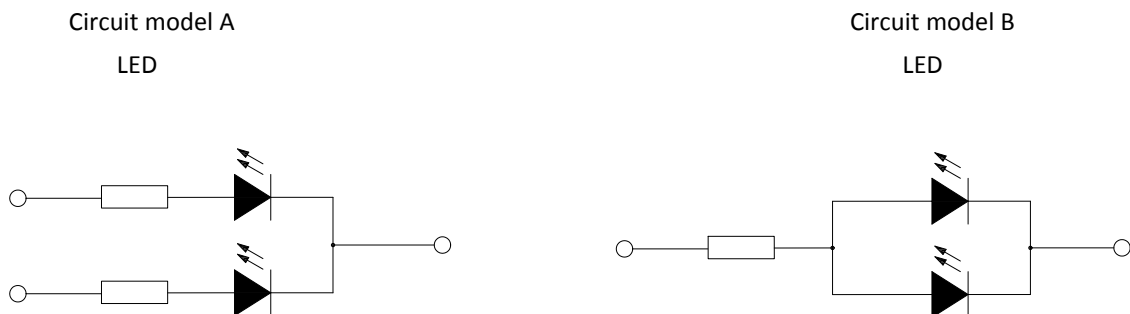
3.6. Because different board designs use different number and types of devices, solder pastes, reflow ovens, and circuit boards, no single temperature profile works for all possible combinations.

However, you can successfully mount your packages to the PCB by following the proper guidelines and PCB-specific characterization

## 4. Drive Method

4.1. An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel

in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.



- Recommended circuit.
- The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

## 5. ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or “no lightup” at low currents. To verify for ESD damage, check for “lightup” and  $V_f$  of the suspect LEDs at low currents. The  $V_f$  of “good” LEDs should be  $>2.0V@0.1mA$  for InGaN product and  $>1.4V@0.1mA$  for AlInGaP product.

Art. Nr.  
RND 135-00242